

HAT2167H

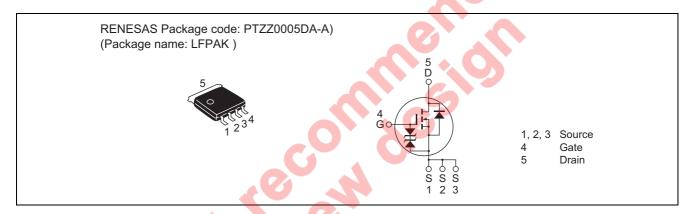
Silicon N Channel Power MOS FET Power Switching

REJ03G0039-0500 Rev.5.00 Sep 20, 2005

Features

- High speed switching
- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)}\!=4.2~\text{m}\Omega~\text{typ.}~(\text{at }V_{GS}=10~\text{V})$

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	40	А
Drain peak current	I _{D(pulse)} Note1	160	А
Body-drain diode reverse drain current	I_{DR}	40	А
Avalanche current	I _{AP} Note 2	20	А
Avalanche energy	E _{AR} Note 2	40	mJ
Channel dissipation	Pch Note3	20	W
Channel to Case Thermal Resistance	θch-C	6.25	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

- 2. Value at Tch = 25°C, Rg \geq 50 Ω
- 3. $Tc = 25^{\circ}C$

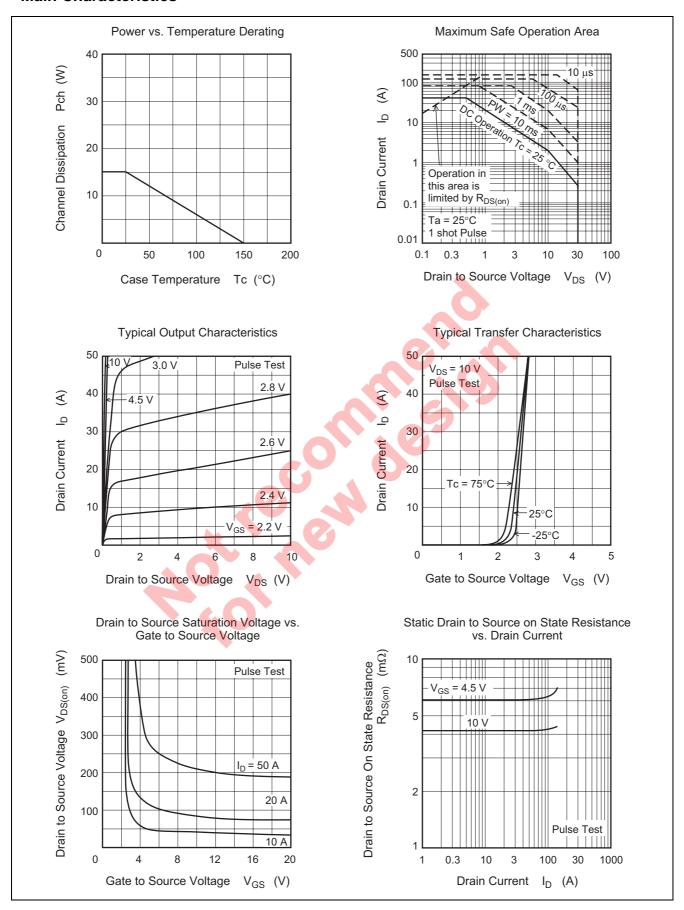
Electrical Characteristics

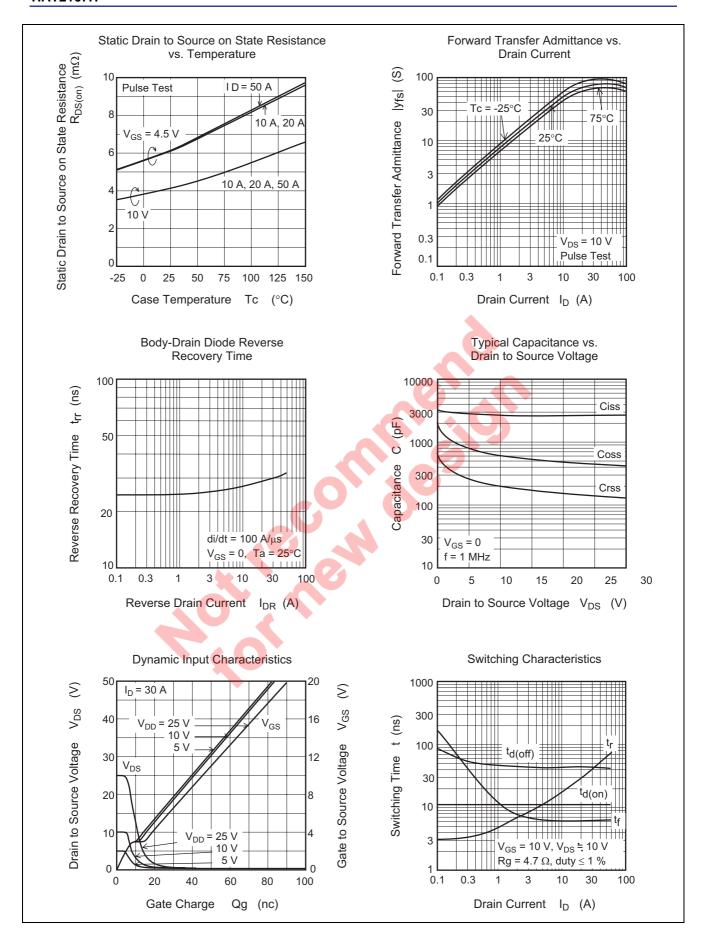
 $(Ta = 25^{\circ}C)$

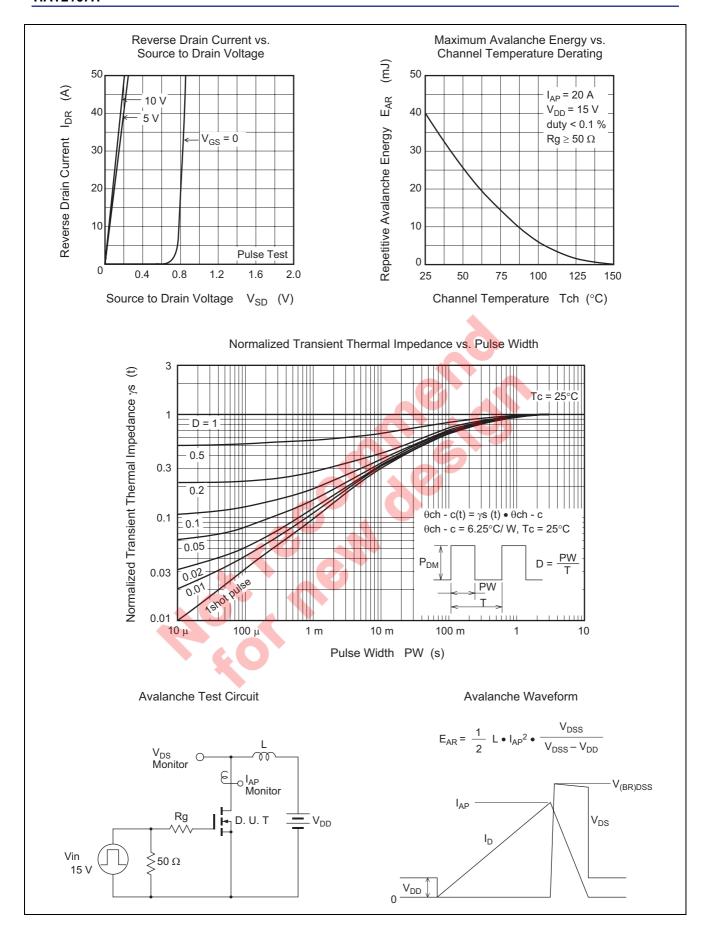
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_		V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	4.2	5.5	mΩ	$I_D = 20 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	6.1	9.3	$m\Omega$	$I_D = 20 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	42	70	1	S	$I_D = 20 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	2700	1	рF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	620		рF	f = 1 MHz
Reverse transfer capacitance	Crss	_	200	_	pF	
Gate resistance	Rg	_	0.5		Ω	
Total gate charge	Qg	_	17		nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs	_	8		nC	$I_D = 40 A$
Gate to drain charge	Qgd	_	3.7		nC	
Turn-on delay time	t _{d(on)}	_	11	<u> </u>	ns	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A},$
Rise time	t _r	_	30	4	ns	$V_{DD} \cong 10 \text{ V}, R_L = 0.5 \Omega,$
Turn-off delay time	$t_{d(off)}$	_	45		ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	6	1	ns	
Body–drain diode forward voltage	V_{DF}	_	0.85	1.10	V	IF = 40 A, V _{GS} = 0 Note4
Body-drain diode reverse recovery	t _{rr}	_	30		ns	$IF = 40 A, V_{GS} = 0,$
time						di _F / dt = 100 A/ μs
time Notes: 4. Pulse test						

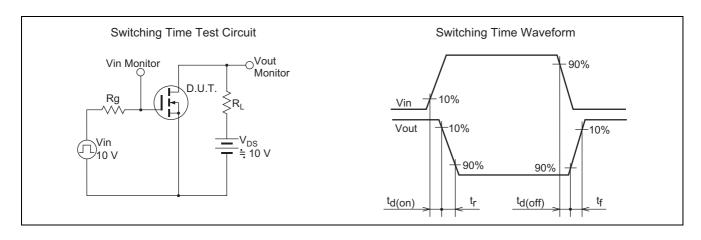
Notes: 4. Pulse test

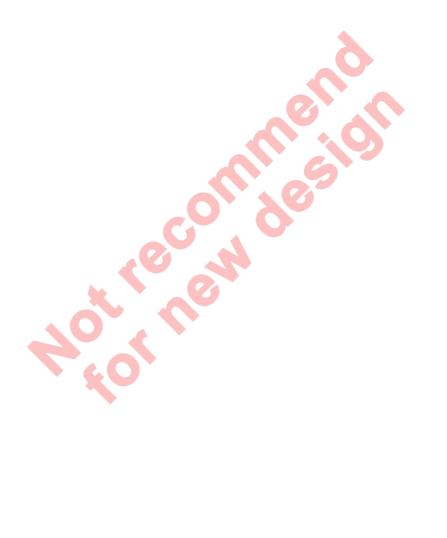
Main Characteristics



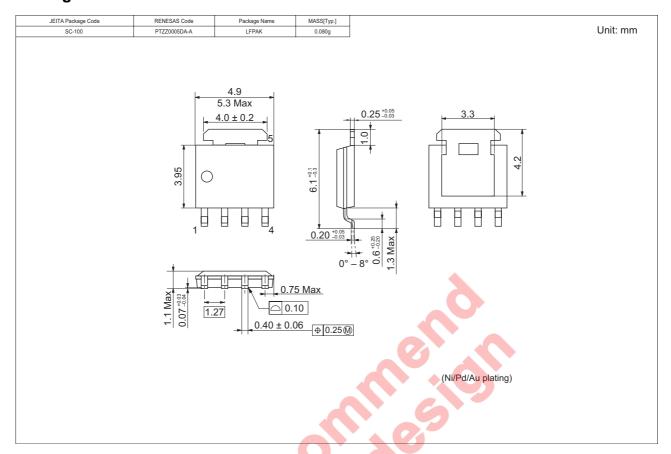








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2167H-EL-E	2500 pcs	Taping

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